

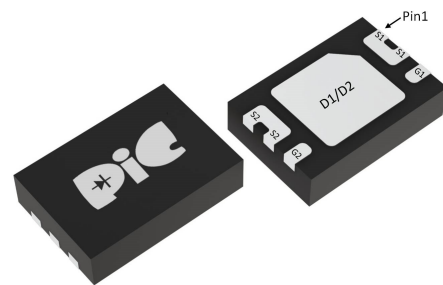
## ➤ General Description

The PAN82TE11F is the low RDSON trenched N-CH MOSFETs with robust ESD protection. This product is suitable for Lithium-ion battery pack applications. The efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

## ➤ Feature

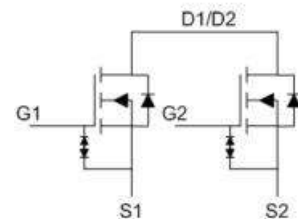
- Low drain-source ON resistance
- Green Device Available
- ESD Protected Embedded
- DFN2X3-6L package design

## ➤ DFN2X3-6L



## ➤ Application

- Load Switch
- Portable Equipment
- Battery Powered System



## ➤ Absolute Maximum Ratings

Parameter	Symbol	Rating	Units
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Continuous Drain Current, $V_{GS} @ 4.5V_1$	$I_D @ T_A=25^\circ C$	8	A
Continuous Drain Current, $V_{GS} @ 4.5V_1$	$I_D @ T_A=70^\circ C$	6.4	A
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	50	A
Total Power Dissipation <sup>1</sup>	$P_D @ T_A=25^\circ C$	1.56	W
Storage Temperature Range	$T_{STG}$	-55 to 150	$^\circ C$
Operating Junction Temperature Range	$T_J$	-55 to 150	$^\circ C$
Thermal Resistance Junction-Ambient <sup>1</sup> ( $t \leq 10s$ )	$R_{\theta JA}$	80	$^\circ C/W$

## ➤ Electrical Characteristics ( $T_J=25^\circ C$ Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	20	---	---	V
Static Drain-Source On-Resistance <sup>2</sup>	$R_{DS(ON)}$	$V_{GS}=4.5V, I_D=2A$	7	9	13	m $\Omega$
		$V_{GS}=4.0V, I_D=2A$	7.5	9.5	13.5	
		$V_{GS}=3.7V, I_D=2A$	8	10	14.5	
		$V_{GS}=3.1V, I_D=2A$	8.5	11	16.5	
		$V_{GS}=2.5V, I_D=2A$	9.5	12.5	20	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	0.5	---	1.2	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=16V, V_{GS}=0V, T_J=25^\circ C$	---	---	1	uA
		$V_{DS}=16V, V_{GS}=0V, T_J=55^\circ C$	---	---	5	
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 8V, V_{DS}=0V$	---	---	$\pm 10$	uA
Forward Transconductance	$g_{fs}$	$V_{DS}=5V, I_D=4A$	---	32	---	S
Total Gate Charge (4.5V)	$Q_g$	$V_{DS}=15V, V_{GS}=4.5V, I_D=3A$	---	10.6	---	nC
Gate-Source Charge	$Q_{gs}$		---	2.2	---	
Gate-Drain Charge	$Q_{gd}$		---	4.1	---	
Turn-On Delay Time	$T_{d(on)}$	$V_{DD}=15V, V_{GS}=4.5V, R_G=6\Omega, I_D=3A$	---	6.9	---	ns
Rise Time	$T_r$		---	37	---	
Turn-Off Delay Time	$T_{d(off)}$		---	45	---	
Fall Time	$T_f$		---	14	---	
Input Capacitance	$C_{iss}$	$V_{DS}=10V, V_{GS}=0V, f=1MHz$	---	734	---	pF
Output Capacitance	$C_{oss}$		---	84	---	
Reverse Transfer Capacitance	$C_{rss}$		---	80	---	

## ➤ Diode Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Continuous Source Current <sup>1</sup>	$I_S$	$V_G=V_D=0V, \text{Force Current}$	---	---	8	A
Diode Forward Voltage <sup>2</sup>	$V_{SD}$	$V_{GS}=0V, I_S=1.0A, T_J=25^\circ C$	---	---	1.2	V

1. The data tested by surface mounted on a 1 inch<sub>2</sub> FR 4 board with 2OZ copper,  $t \leq 10s$ .

2. The data tested by pulsed, pulse width  $\leq 10\mu s$ , duty cycle  $\leq 1\%$

### ➤ Typical Characteristics

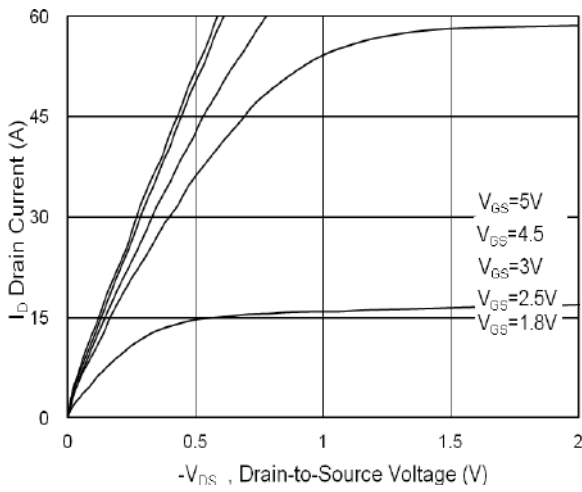


Fig.1 Typical Output Characteristics

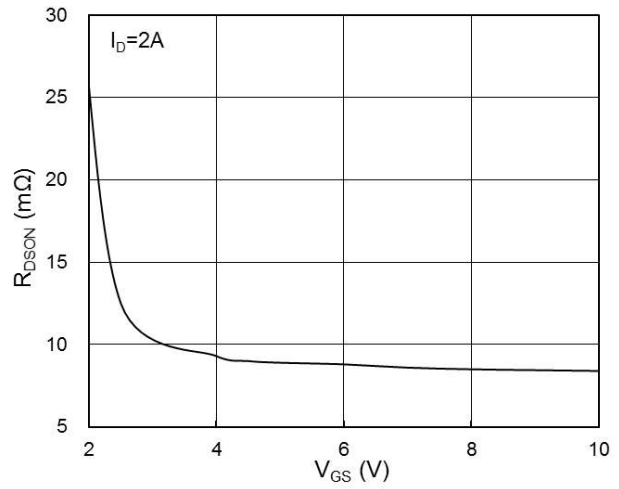


Fig.2 On-Resistance vs. G-S Voltage

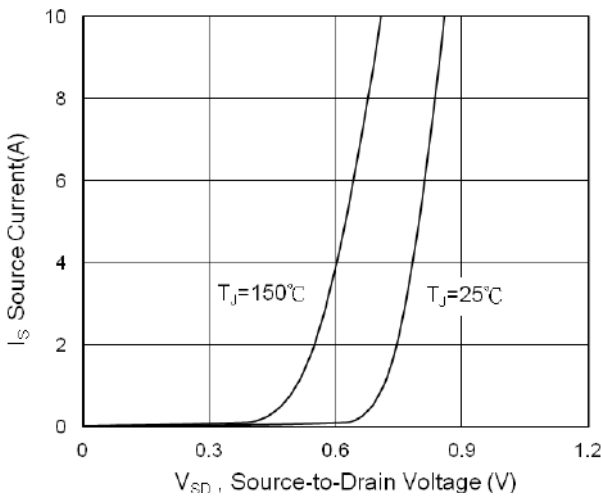


Fig.3 Forward Characteristics of Reverse

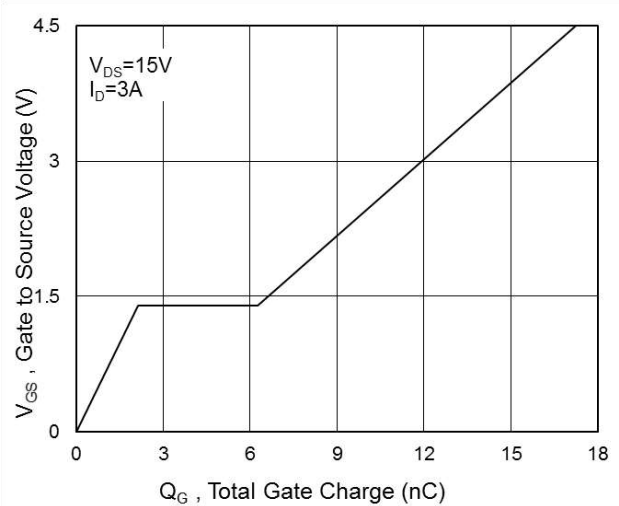


Fig.4 Gate-Charge Characteristics

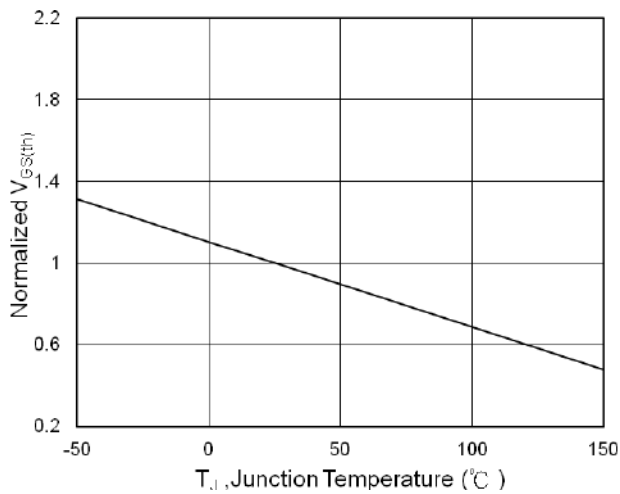


Fig.5  $V_{GS(th)}$  vs.  $T_J$

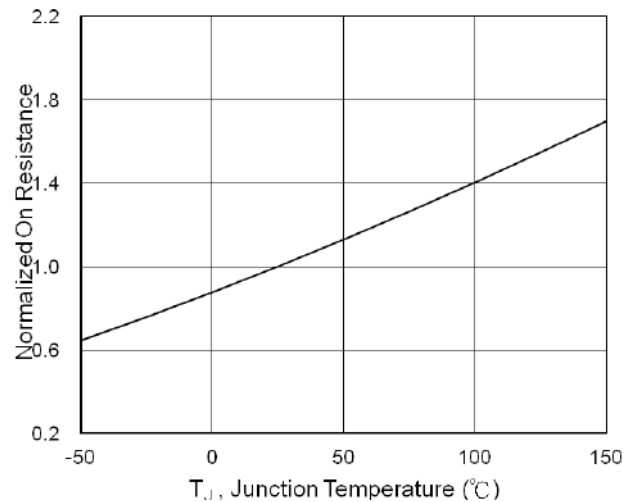


Fig.6 Normalized  $R_{DS(ON)}$  vs.  $T_J$

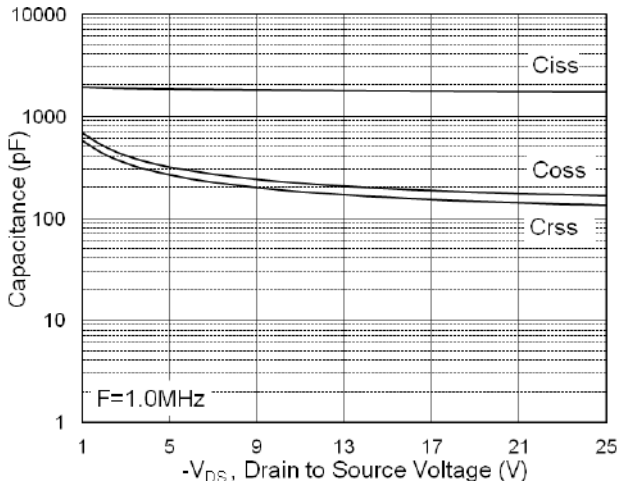


Fig.7 Capacitance

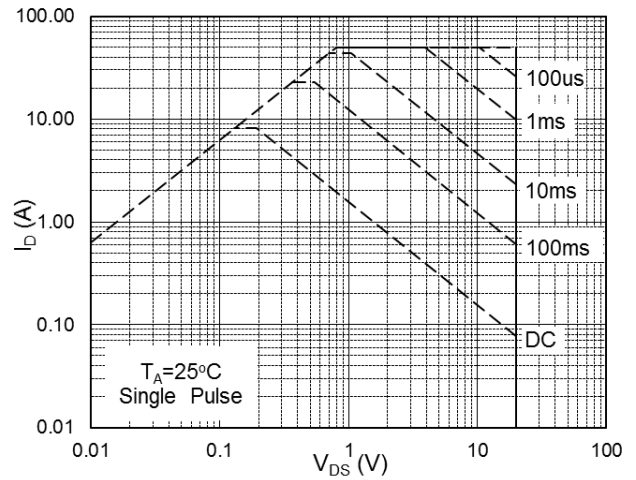


Fig.8 Safe Operating Area

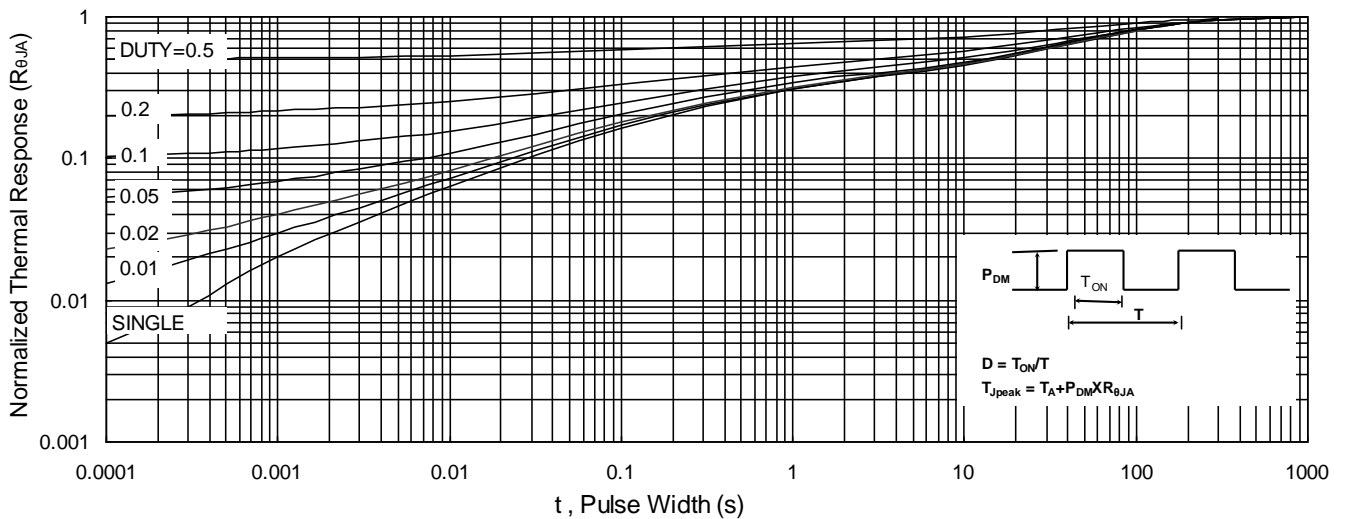


Fig.9 Normalized Maximum Transient Thermal Impedance

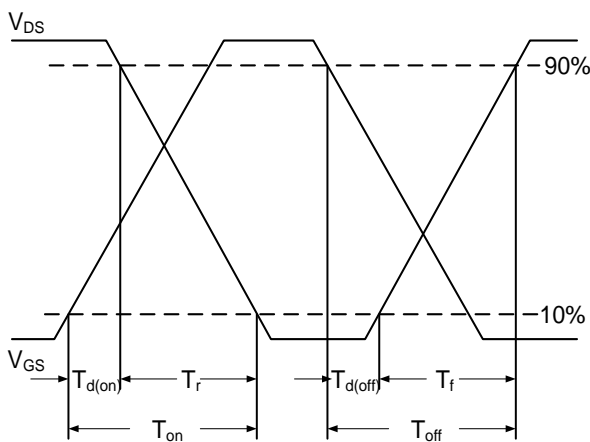


Fig.10 Switching Time Waveform

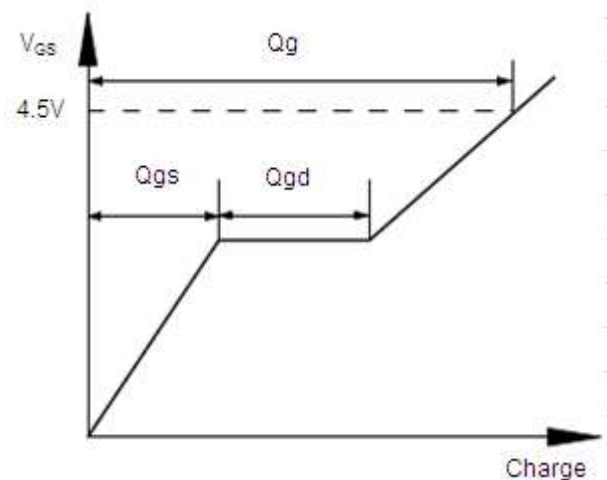
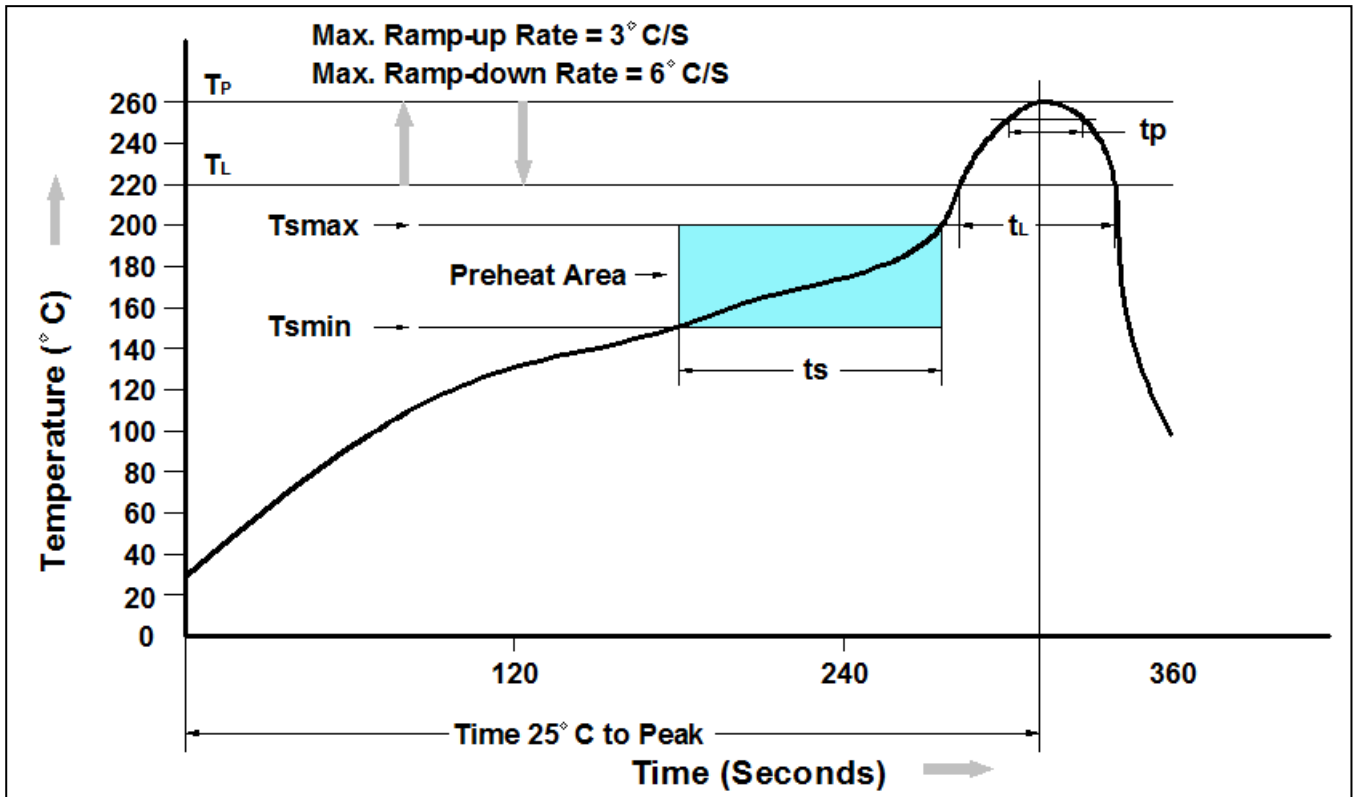


Fig.11 Gate Charge Waveform

## ➤ Recommend IR Reflow Soldering Thermal Profile

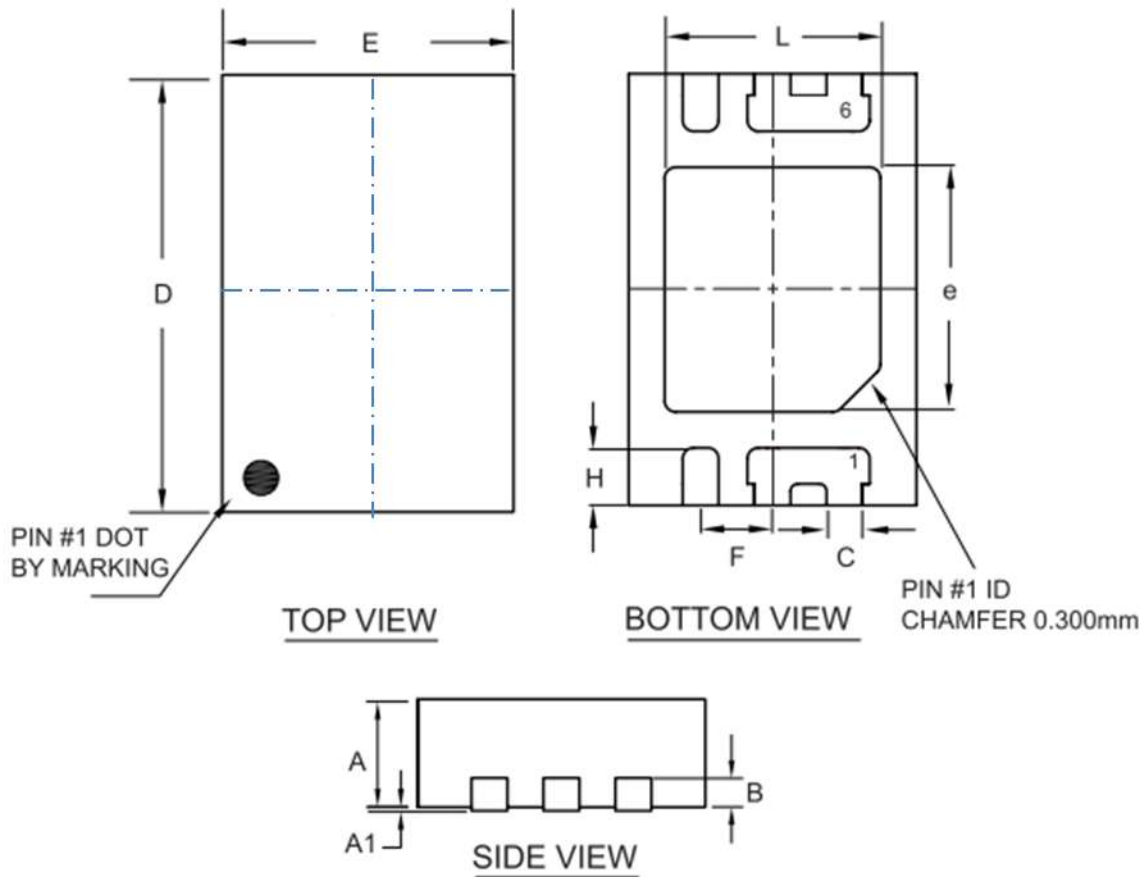


Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T <sub>smin</sub> )	150°C
Temperature Max. (T <sub>smax</sub> )	200°C
Time (t <sub>s</sub> ) from (T <sub>smin</sub> to T <sub>smax</sub> )	60-120 seconds
Average Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

## ➤ Ordering Information

Part Number	Description	Quantity
PAN82TE11F	DFN2X3-6L Reel	3000 pcs

### ➤ Package Information ( DFN2X3-6L )



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
D	2.950	3.050	0.116	0.120
E	1.950	2.050	0.077	0.081
H	0.350	0.450	0.014	0.018
L	1.450	1.550	0.057	0.061
e	1.650	1.750	0.065	0.069
B	0.195	0.211	0.0076	0.008
C	0.200	0.300	0.008	0.012
F	0.500 BSC		0.020 BSC	

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